

CESION

El (la) abajo firmante (En adelante EL CEDENTE)

1. CHAEN, Takashi
2. OHTSUKA, Toshiaki
3. IIDA, Kenji
4. NAKAMURA, Kensuke
5. ABURATANI, Takahide
6. ICHIKAWA, Junya
7. KUDO, Shota
8. PISCITELLI, Chayne Lee
9. SANCHES, Mario

en su carácter de inventor /diseñador con domicilio en:

1. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
2. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
3. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
4. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
5. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
6. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
7. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
8. 104-2100 3rd Ave West, Vancouver, BC, V6K 1L1, CA
9. 3157 West 7th Ave, Vancouver, BC, V6K 1Z9, CA

por el presente documento declara que cede todos y cada uno de los derechos que le corresponden o puedan corresponderle sobre la siguiente invención, modelo de utilidad, diseño industrial No. **PCT/JP2018/003888**

a: DAIICHI SANKYO COMPANY, LIMITED

con domicilio en 3-5-1, Nihonbashi Honcho, Chuo-ku Tokyo 1038426, Japón.

En prueba de la mutua aceptación de esta cesión ambas partes CEDENTE y CESIONARIO firman el presente documento.

Dado y firmado en _____

A los _____ días de _____ de _____

1.

El Cedente

2.

El Cedente

3.

El Cedente

ASSIGNMENT

The undersigned (Hereinafter THE ASSIGNOR)

1. CHAEN, Takashi
2. OHTSUKA, Toshiaki
3. IIDA, Kenji
4. NAKAMURA, Kensuke
5. ABURATANI, Takahide
6. ICHIKAWA, Junya
7. KUDO, Shota
8. PISCITELLI, Chayne Lee
9. SANCHES, Mario

Inventor /designer of domiciled at

1. c/o DAIICHI SANKYO COMPANY, LIMITED, 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo, 1038426 JP
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9. 3157 West 7th Ave, Vancouver, BC, V6K 1Z9, CA

Do hereby declare that it assigns all and each of his rights and privileges on the following invention, industrial design, utility model No. **PCT/JP2018/003888**

to: DAIICHI SANKYO COMPANY, LIMITED

with domicile in 3-5-1, Nihonbashi Honcho, Chuo-ku Tokyo 1038426, Japan

As a proof of the mutual acceptance of this assignment, both parties ASSIGNOR and ASSIGNEE sign the present document.

Granted and signed at Tokyo, Japan

on this 15th day of November of 2019

1.

Takashi Chaen
The Assignor

2.

Toshiaki Ohtsuka
The Assignor

3.

Kenji Iida
The Assignor

4.

El Cedente

5.

El Cedente

6.

El Cedente

7.

El Cedente

8.

El Cedente

9.

El Cedente

El Cesionario

4.

Kensuke Nakamura
The Assignor

5.

Fukuhito Akutani
The Assignor

6.

Tsuyoshi Ichi
The Assignor

7.

Shota Kudo
The Assignor

8.

The Assignor

9.

The Assignor

DAIICHI SANKYO COMPANY, LIMITED

Yoshiida
The Assignee
By: Yohei ISHIDA
Vice President, Intellectual Property